

TMP461-EP (Enhanced Product), High-Accuracy Remote and Local Temperature Sensor with Pin-Programmable Bus Address

1 Features

- Remote diode temperature sensor accuracy: $\pm 1^{\circ}\text{C}$
- Local temperature sensor accuracy: $\pm 1^{\circ}\text{C}$
- Resolution for local and remote channels: 0.0625°C
- Supply and logic voltage range: 1.7V to 3.6V
- 35 μA operating current (1 SPS), 3 μA shutdown current
- Series resistance cancellation
- η -Factor and offset correction
- Programmable digital filter
- Diode fault detection
- Two-wire and SMBus™ serial interface compatible with pin-programmable address
- 10-Lead VSSOP package
- Supports defense, aerospace, and medical applications
 - Military temperature range (-55°C to 125°C)
 - Controlled baseline
 - One fabrication, assembly, and test site
 - Extended product life cycle
 - Wafer lot traceability

2 Applications

- Processor Temperature Monitoring
- [Aerospace and defense](#); ruggedized communication
- [Avionics](#)
- [Sensors, imaging, and radar](#); [electronic warfare](#); [radar](#)
- [Seeker front end](#)

3 Description

The TMP461-EP device is a high-accuracy, low-power remote temperature sensor monitor with a built-in local temperature sensor. The remote temperature sensors are typically low-cost discrete NPN or PNP transistors, or substrate thermal transistors or diodes that are integral parts of microprocessors, microcontrollers, or field-programmable gate arrays (FPGAs). Temperature is represented as a 12-bit digital code for both local and remote sensors, giving a resolution of 0.0625°C . The two-wire serial interface accepts the SMBus communication protocol with up to nine different pin-programmable addresses.

Advanced features [such as series resistance cancellation, programmable nonideality factor (η -factor), programmable offset, programmable temperature limits, and a programmable digital filter] are combined to provide a robust thermal monitoring solution with improved accuracy and noise immunity.

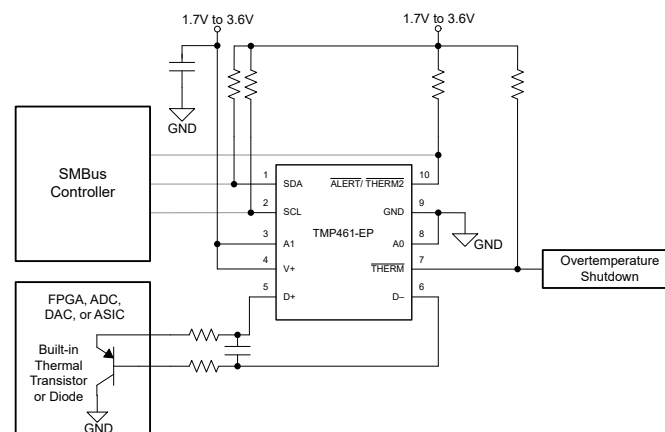
The TMP461-EP is ideal for multi-location, high-accuracy temperature measurements in a variety of communication, computing, instrumentation, and industrial applications. The device is specified for operation over a supply voltage range of 1.7V to 3.6V, and a temperature range of -55°C to 125°C .

Table 3-1. Package Information

DEVICE	PACKAGE ⁽¹⁾	PACKAGE SIZE ⁽²⁾
TMP461-EP	DGS (VSSOP, 10)	4.9mm × 3.0mm

(1) For more information, see [Section 12](#).

(2) The package size (length × width) is a nominal value and includes pins, where applicable.



Simplified Schematic



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4 Device Information

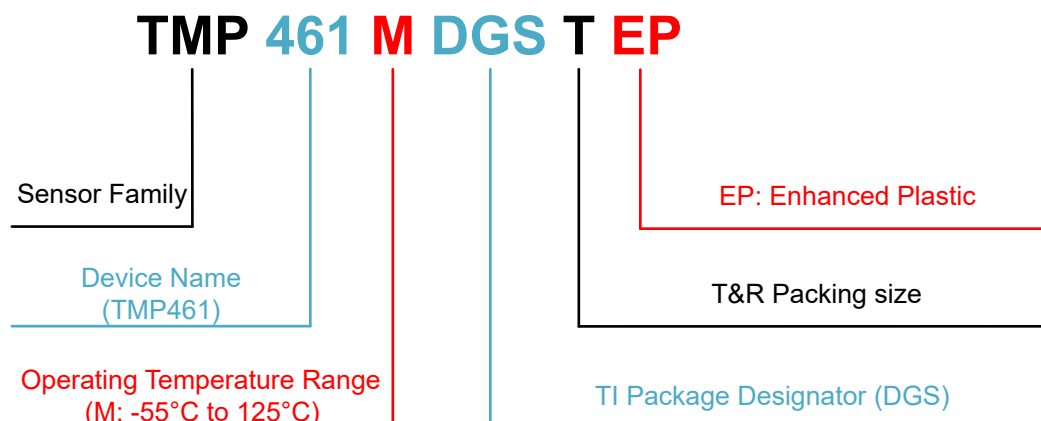
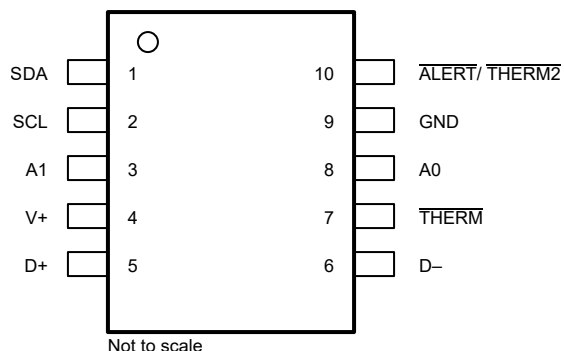


Figure 4-1. TMP461-EP Device Nomenclature

Table 4-1. TMP461MDGSTEP Device Nomenclature Description

FIELD DESCRIPTION	FIELD DETAILS
Sensor Family	TMP: Temperature Sensors
Device Name	461
Operating Temperature Range	M: -55°C to 125°C
TI Package Designator	DGS: 10-pin VSSOP package, 1.1mm (max) height
T&R Packing Size	T: Small reel, SPQ = 250 units
Defense and Military qualified	EP: Enhanced Plastic

5 Pin Configuration and Functions



**Figure 5-1. DGS Package
10-Pin VSSOP
(Top View)**

Table 5-1. Pin Functions

PIN NUMBER	PIN NAME	TYPE ⁽¹⁾	DESCRIPTION
1	SDA	Digital I/O	Serial data line for SMBus. Open-drain; requires a pullup resistor to a voltage between 1.7V and 3.6V
2	SCL	Digital I	Serial clock line for SMBus. Input; requires a pullup resistor to a voltage between 1.7V and 3.6V if driven by an open-drain output
3	A1	Digital I	Address select. Connect to GND, V+, or leave floating.
4	V+	P	Positive supply voltage, 1.7V to 3.6V
5	D+	Analog I	Positive connection to the remote temperature sensor
6	D–	Analog I	Negative connection to the remote temperature sensor
7	THERM	Digital O	Thermal shutdown or fan-control pin. Open-drain; requires a pullup resistor to a voltage between 1.7V and 3.6V
8	A0	Digital I	Address select. Connect to GND, V+, or leave floating
9	GND	G	Supply ground connection
10	ALERT/ THERM2	Digital O	Interrupt or SMBus alert output. Can be configured as a second THERM output. Open-drain; requires a pullup resistor to a voltage between 1.7V and 3.6V

(1) I = Input; O = Output; I/O = Input or Output; P = Positive Supply; G = Ground

6 Specifications

6.1 Absolute Maximum Ratings

Over operating free-air temperature range (unless otherwise noted)⁽¹⁾

		MIN	MAX	UNIT
Power supply	V+	–0.3	6	V
Input voltage	THERM, ALERT/THERM2, SDA, and SCL only	–0.3	6	V
	D+, A0, A1	–0.3	(V+) + 0.3	
	D– only	–0.3	0.3	
Input current			10	mA
Operating temperature		–55	150	°C
Junction temperature, T _J max			150	°C
Storage temperature, T _{stg}		–60	150	°C

- (1) Operation outside the Absolute Maximum Ratings may cause permanent device damage. Absolute Maximum Ratings do not imply functional operation of the device at these or any other conditions beyond those listed under Recommended Operating Conditions. If used outside the Recommended Operating Conditions but within the Absolute Maximum Ratings, the device may not be fully functional, and this may affect device reliability, functionality, performance, and shorten the device lifetime.

6.2 ESD Ratings

			VALUE	UNIT
V _(ESD)	Electrostatic discharge	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾	±2000	V
		Charged device model (CDM), JEDEC specification JESD22-C101 ⁽²⁾	±1000	

- (1) JEDEC document JEP155 states that 500V HBM allows safe manufacturing with a standard ESD control process.
(2) JEDEC document JEP157 states that 250V CDM allows safe manufacturing with a standard ESD control process.

6.3 Recommended Operating Conditions

Over operating free-air temperature range (unless otherwise noted)

		MIN	NOM	MAX	UNIT
V+	Supply voltage	1.7	3.3	3.6	V
T _A	Operating temperature	–55		125	°C

6.4 Thermal Information

THERMAL METRIC ⁽¹⁾		TMP461-EP	UNIT
		DGS (VSSOP)	
		10 PINS	
R _{θJA}	Junction-to-ambient thermal resistance	138.3	°C/W
R _{θJC(top)}	Junction-to-case (top) thermal resistance	47.9	°C/W
R _{θJB}	Junction-to-board thermal resistance	73.4	°C/W
Ψ _{JT}	Junction-to-top characterization parameter	2.0	°C/W
Ψ _{JB}	Junction-to-board characterization parameter	72	°C/W
R _{θJC(bot)}	Junction-to-case (bottom) thermal resistance	N/A	°C/W

- (1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application note.

6.5 Electrical Characteristics

At $T_A = -55^{\circ}\text{C}$ to 125°C and $V_+ = 1.7\text{V}$ to 3.6V , unless otherwise noted

PARAMETER		CONDITIONS	MIN	TYP	MAX	UNIT
TEMPERATURE MEASUREMENT						
T_{LOCAL}	Local temperature sensor accuracy	$T_A = -10^{\circ}\text{C}$ to 100°C	-1	± 0.125	1	$^{\circ}\text{C}$
		$T_A = -55^{\circ}\text{C}$ to 125°C	-1.25	± 0.5	1.25	
T_{REMOTE}	Remote temperature sensor accuracy	$T_A = 0^{\circ}\text{C}$ to 100°C , $T_D = -55^{\circ}\text{C}$ to 150°C	-1	± 0.125	1	$^{\circ}\text{C}$
		$T_A = -55^{\circ}\text{C}$ to 125°C , $T_D = -55^{\circ}\text{C}$ to 150°C	-1.5	± 0.5	1.5	
$T_{\text{ERROR_PS}}$	Temperature sensor error versus supply (local or remote)	$V_+ = 1.7\text{V}$ to 3.6V	-0.3	± 0.1	0.3	$^{\circ}\text{C/V}$
T_{RES}	Temperature resolution (local and remote)			0.0625		$^{\circ}\text{C}$
	ADC resolution			12		Bits
t_{CONV}	ADC conversion time	One-shot mode, per channel (local or remote)		15	17	ms
R_{SERIES}	Remote sensor source current	High	85	120	155	μA
		Medium	30	45	60	
		Low	5	7.5	10	
η	Remote transistor ideality factor	TMP461-EP optimized ideality factor		1.008		
SERIAL INTERFACE (SCL, SDA)						
V_{IH}	High-level input voltage		1.4			V
V_{IL}	Low-level input voltage				0.45	V
V_{HYST}	Hysteresis			200		mV
	SDA output-low sink current		6			mA
V_{OL}	Low-level output voltage	$I_O = -6\text{mA}$		0.15	0.4	V
I_{IN}	Serial bus input leakage current	$0\text{V} \leq V_{\text{IN}} \leq 3.6\text{V}$	-1		1	μA
C_{IN}	Serial bus input capacitance	SCL		3.5		pF
		SDA		5		pF
	Serial bus clock frequency				2.17	MHz
	Serial bus timeout		20	25	30	ms
DIGITAL INPUTS (A0, A1)						
V_{IH}	High-level input voltage		$0.9 \times (V_+)$		$(V_+) + 0.3$	V
V_{IL}	Low-level input voltage		-0.3		$0.1 \times (V_+)$	V
I_{IN}	Input leakage current	$0\text{V} \leq V_{\text{IN}} \leq 3.6\text{V}$	-1		1	μA
C_{IN}	Input capacitance			4.5		pF
DIGITAL OUTPUTS (THERM1, ALERT/THERM2)						
	Output-low sink current		6			mA
V_{OL}	Low-level output voltage	$I_O = -6\text{mA}$		0.15	0.4	V
I_{OH}	High-level output leakage current	$V_O = V_+$			1	μA
POWER SUPPLY						
V_+	Specified supply voltage range		1.7		3.6	V
I_Q	Quiescent current	Active conversion, local sensor		240	375	μA
		Active conversion, remote sensors		400	600	
		Standby mode (between conversions)		15	35	
		Shutdown mode, serial bus inactive		3	8	
		Shutdown mode, serial bus active, $f_S = 400\text{kHz}$		90		
		Shutdown mode, serial bus active, $f_S = 2.17\text{MHz}$		350		
POR	Power-on reset threshold	Rising edge		1.41	1.55	V

6.6 Two-Wire Timing Requirements

At –55°C to 125°C and V+ = 1.7V to 3.6V, unless otherwise noted

		FAST-MODE		FAST-MODE PLUS		HIGH-SPEED MODE		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	
$f_{(SCL)}$	SCL operating frequency	0.001	0.4	0.001	1.0	0.001	2.17	MHz
$t_{(BUF)}$	Bus free time between stop and start condition	1300		500		160		ns
$t_{(HDSTA)}$	Hold time after repeated start condition. After this period, the first clock is generated.	600		260		160		ns
$t_{(SUSTA)}$	Repeated start condition setup time	600		260		160		ns
$t_{(SUSTO)}$	Stop condition setup time	600		260		160		ns
$t_{(HDDAT)}$	Data hold time	0	900	0	450	0	150	ns
$t_{(SUDAT)}$	Data setup time	100		50		40		ns
$t_{(LOW)}$	SCL clock low period	1300		500		320		ns
$t_{(HIGH)}$	SCL clock high period	600		260		60		ns
$t_F - SDA$	Data fall time		300		120		130	ns
$t_F, t_R - SCL$	Clock fall and rise time		300		120		40	ns
t_R	Rise time for SCL ≤ 100 kHz		1000					ns

6.7 Timing Diagrams

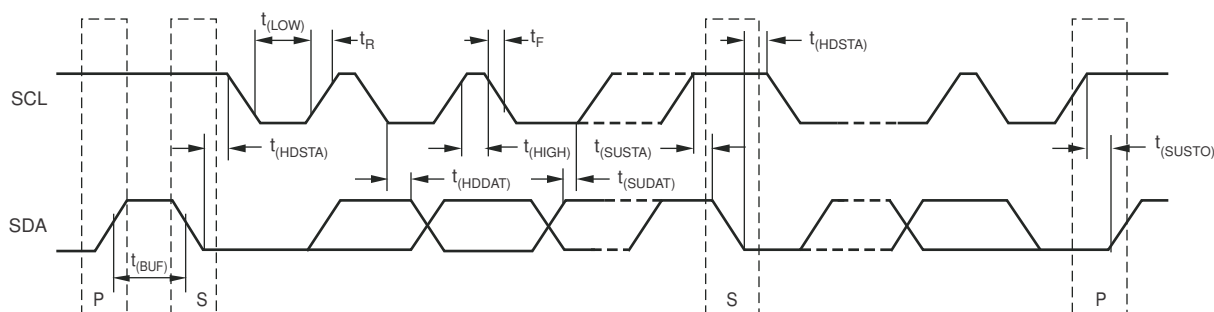


Figure 6-1. Two-Wire Timing Diagram

6.8 Typical Characteristics

At $T_A = 25^\circ\text{C}$ and $V+ = 3.6\text{V}$, unless otherwise noted

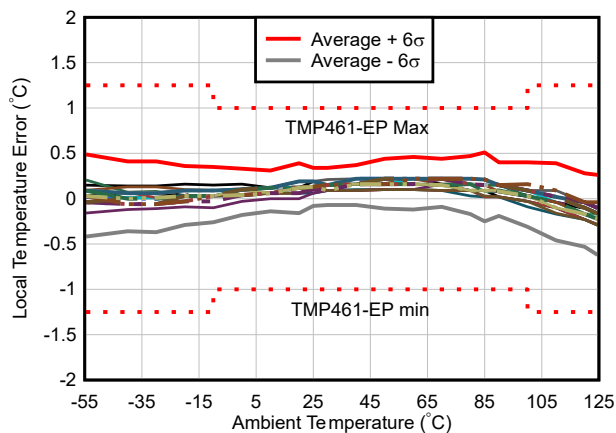


Figure 6-2. Local Temperature Error vs Ambient Temperature

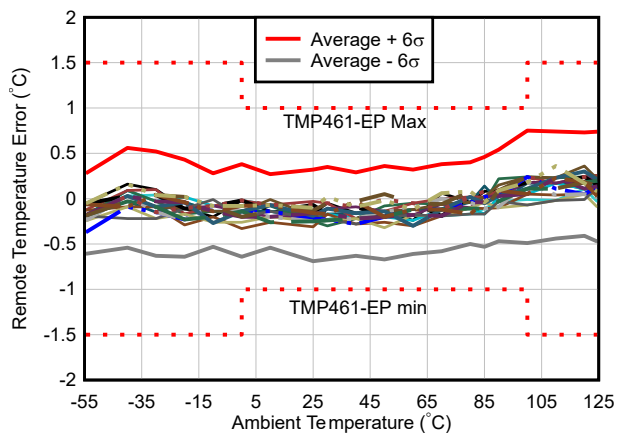


Figure 6-3. Remote Temperature Error vs Ambient Temperature

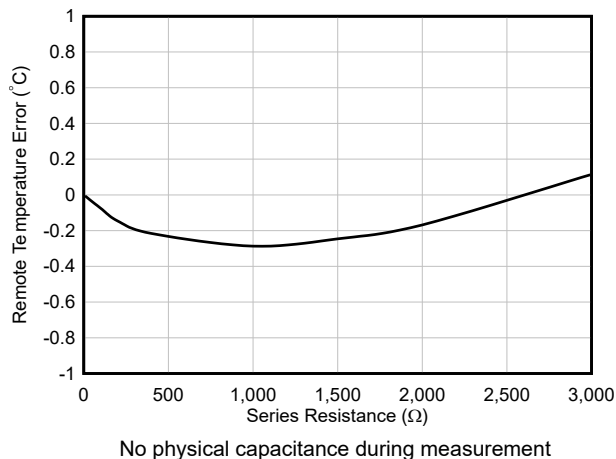


Figure 6-4. Remote Temperature Error vs Series Resistance

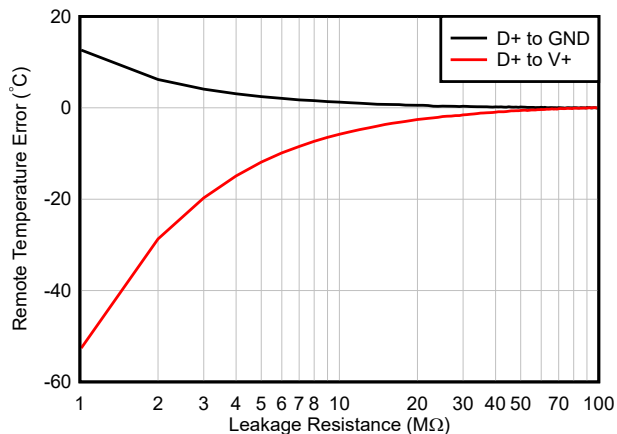
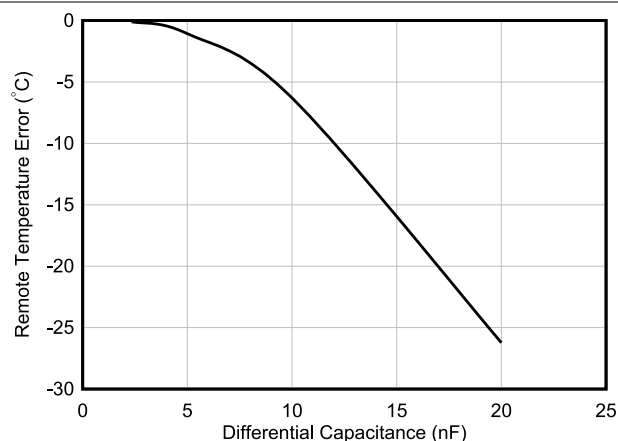


Figure 6-5. Remote Temperature Error vs Leakage Resistance



No physical series resistance on D+, D– pins during measurement

Figure 6-6. Remote Temperature Error vs Differential Capacitance

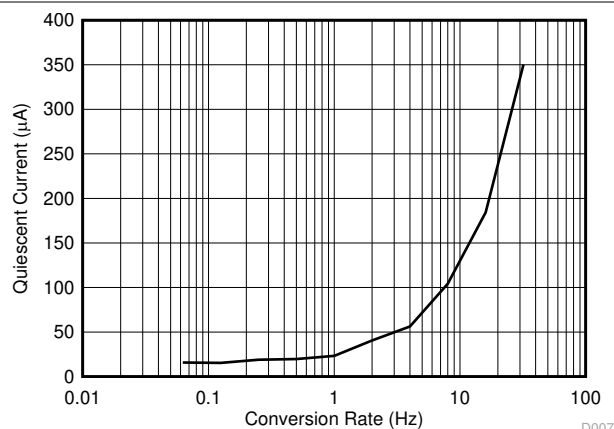
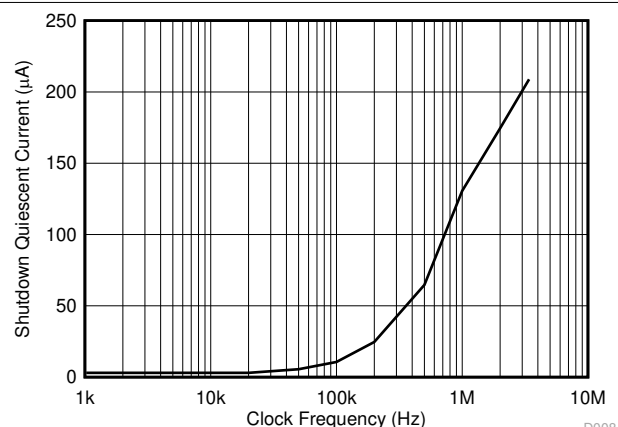


Figure 6-7. Average Current vs Conversion Rate



16 samples per second (default mode)

Figure 6-8. Shutdown Current vs SCL Clock Frequency

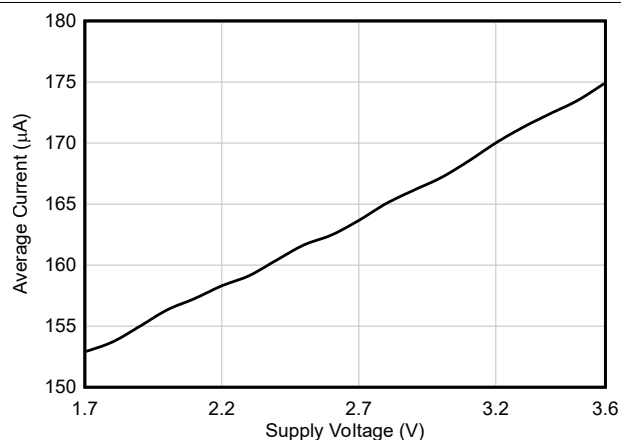


Figure 6-9. Average Current vs Supply Voltage (at Default Conversion Rate of 16Hz)

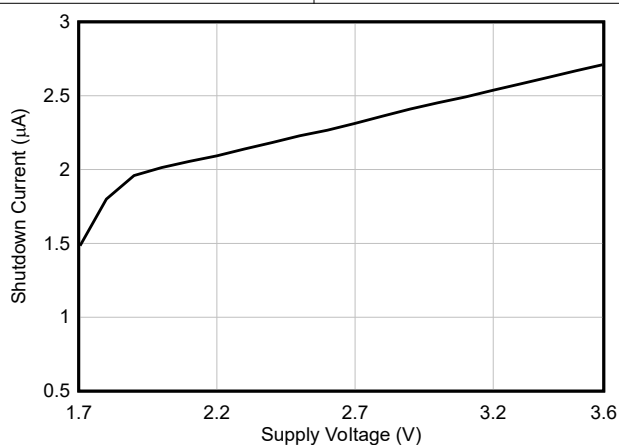


Figure 6-10. Shutdown Current vs Supply Voltage (Serial Bus Inactive)

7 Detailed Description

7.1 Overview

The TMP461-EP device is a digital temperature sensor that combines a local temperature measurement channel and a remote-junction temperature measurement channel in a single VSSOP-10 package. The device is two-wire and SMBus-interface-compatible with nine pin-programmable bus address options, and is specified over a temperature range of -55°C to 125°C . The TMP461-EP device also contains multiple registers for programming and holding configuration settings, temperature limits, and temperature measurement results.

7.2 Functional Block Diagram

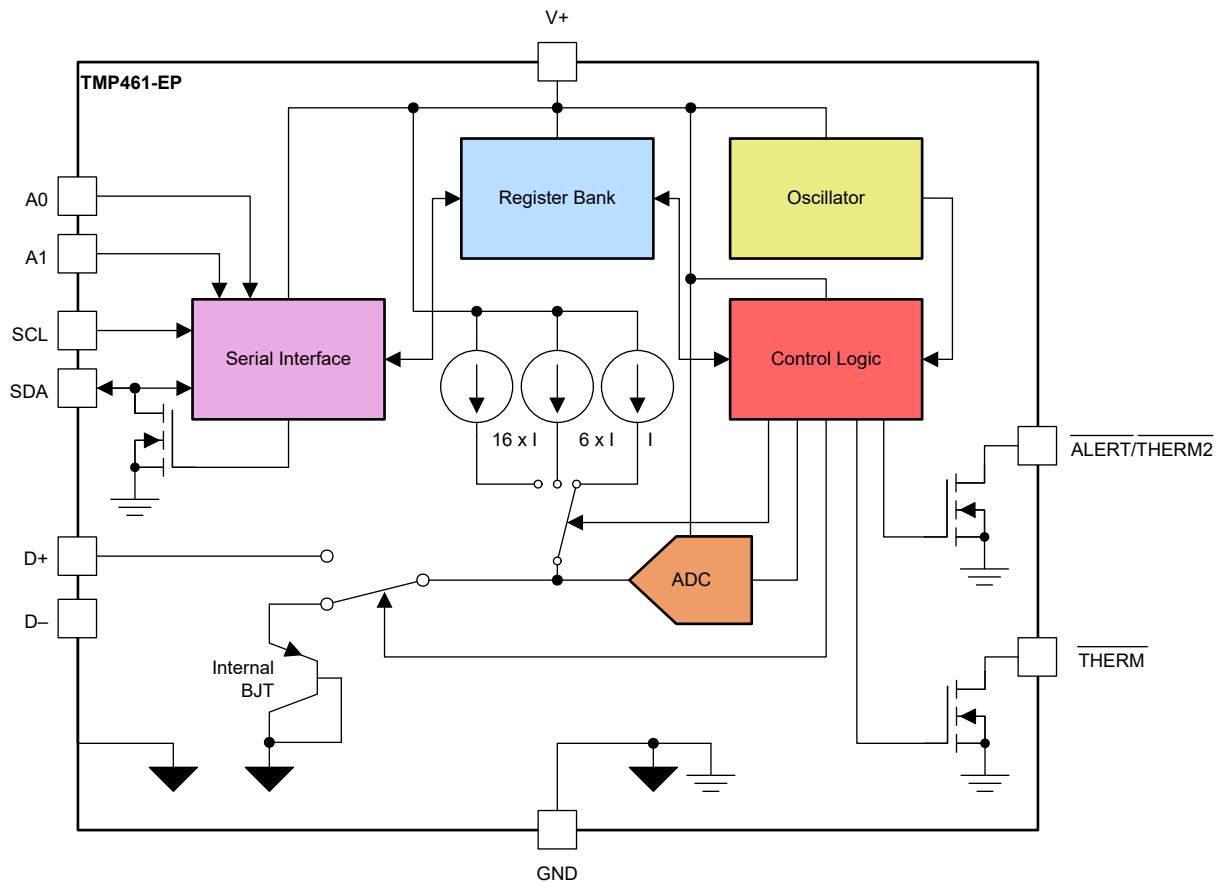


Figure 7-1. Functional Block Diagram

7.3 Feature Description

7.3.1 Temperature Measurement Data

The local and remote temperature sensors have a resolution of 12 bits (0.0625°C). Temperature data that result from conversions within the default measurement range are represented in binary form, as shown in the *Standard Binary* column of [Table 7-1](#). Any temperatures above 127°C result in a value that rails to 127.9375 (7FFh). The device can be set to measure over an extended temperature range by changing bit 2 (RANGE) of the configuration register from low to high. The change in measurement range and data format from standard binary to extended binary occurs at the next temperature conversion. For data captured in the extended temperature range configuration, an offset of 64 (40h) is added to the standard binary value, as shown in the *Extended Binary* column of [Table 7-1](#). This configuration allows measurement of temperatures as low as -64°C , and as high as 191°C ; however, most temperature-sensing diodes only operate within the range of -55°C to 150°C . Additionally, the TMP461-EP is specified only for ambient temperatures ranging from -55°C to 125°C ; parameters in the [Section 6.1](#) table must be observed.

Table 7-1. Temperature Data Format (Local and Remote Temperature High Bytes)

TEMPERATURE (°C)	LOCAL AND REMOTE TEMPERATURE REGISTER HIGH BYTE VALUE (1°C RESOLUTION)			
	STANDARD BINARY ⁽¹⁾		EXTENDED BINARY ⁽²⁾	
	BINARY	HEX	BINARY	HEX
–64	1100 0000	C0	0000 0000	00
–50	1100 1110	CE	0000 1110	0E
–25	1110 0111	E7	0010 0111	27
0	0000 0000	00	0100 0000	40
1	0000 0001	01	0100 0001	41
5	0000 0101	05	0100 0101	45
10	0000 1010	0A	0100 1010	4A
25	0001 1001	19	0101 1001	59
50	0011 0010	32	0111 0010	72
75	0100 1011	4B	1000 1011	8B
100	0110 0100	64	1010 0100	A4
125	0111 1101	7D	1011 1101	BD
127	0111 1111	7F	1011 1111	BF
150	0111 1111	7F	1101 0110	D6
175	0111 1111	7F	1110 1111	EF
191	0111 1111	7F	1111 1111	FF

(1) Resolution is 1°C per count. Negative numbers are represented in 2's complement format.

(2) Resolution is 1°C per count. All values are unsigned with a –64°C offset.

Both local and remote temperature data use two bytes for data storage. The high byte stores the temperature with 1°C resolution. The second or low byte stores the decimal fraction value of the temperature and allows a higher measurement resolution, as shown in [Table 7-2](#). The measurement resolution for both the local and the remote channels is 0.0625°C.

Table 7-2. Decimal Fraction Temperature Data Format (Local and Remote Temperature Low Bytes)

TEMPERATURE (°C)	TEMPERATURE REGISTER LOW BYTE VALUE (0.0625°C RESOLUTION) ⁽¹⁾	
	STANDARD AND EXTENDED BINARY	HEX
0	0000 0000	00
0.0625	0001 0000	10
0.1250	0010 0000	20
0.1875	0011 0000	30
0.2500	0100 0000	40
0.3125	0101 0000	50
0.3750	0110 0000	60
0.4375	0111 0000	70
0.5000	1000 0000	80
0.5625	1001 0000	90
0.6250	1010 0000	A0
0.6875	1011 0000	B0
0.7500	1100 0000	C0
0.8125	1101 0000	D0
0.8750	1110 0000	E0
0.9375	1111 0000	F0

(1) Resolution is 0.0625°C per count. All possible values are shown.

7.3.1.1 Decoding Temperature Data

The TMP461-EP temperature registers use a 12-bit format. The 12 bits are aligned to the left side, or most significant side, of the 16-bit word. The four unused bits are on the right side, or the least significant side. For this reason, a shift is needed to discard the extra bits. 2's complement is employed to describe negative temperatures. C code can easily convert the 2's complement data when the data is typecast into the correct signed data type. Q notation describes the number of bits that represent a fractional result. 4 bits of fractional data, known as Q4, offers 0.0625°C resolution.

Table 7-3. 12-Bit Q4 Encoding Parameters

PARAMETER	VALUE
Bits	12
Q	4
Resolution	0.0625
Range (+)	127.9375
Range (-)	-128
First Byte Integer C	Yes
25°C	0x1900

Table 7-4. 12-Bit Q4 Bit Values

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Sign	64	32	16	8	4	2	1	0.5	0.25	0.125	0.0625	-	-	-	-
-128	64	32	16	8	4	2	1	1/2	1/4	1/8	1/16	-	-	-	-
-2 ⁷	2 ⁶	2 ⁵	2 ⁴	2 ³	2 ²	2 ¹	2 ⁰	2 ⁻¹	2 ⁻²	2 ⁻³	2 ⁻⁴	-	-	-	-

```

/* 12-bit format has 4 bits discarded by right shift
   q4 is 0.062500 resolution
   the following bytes represent 24.5C */
uint8_t byte1 = 0x18;
uint8_t byte2 = 0x80;
float f = (((int8_t) byte1 << 8 | byte2) >> 4) * 0.0625f;
int mC = (((int8_t) byte1 << 8 | byte2) >> 4) * 1000 >> 4;
int C = (int8_t) byte1;

```

7.3.2 Series Resistance Cancellation

Series resistance cancellation automatically eliminates the temperature error caused by the resistance of the routing to the remote transistor or by the resistors of the optional external low-pass filter. A total of up to 1kΩ of series resistance can be canceled by the TMP461-EP device, thus eliminating the need for additional characterization and temperature offset correction. See [Figure 6-3](#) for details on the effects of series resistance on sensed remote temperature error.

7.3.3 Differential Input Capacitance

The TMP461-EP device tolerates differential input capacitance of up to 1000pF with minimal change in temperature error. The effect of capacitance on the sensed remote temperature error is illustrated in [Figure 6-6 \(Remote Temperature Error vs Differential Capacitance\)](#).

7.3.4 Filtering

Remote junction temperature sensors are typically implemented in a noisy environment. Noise is most often created by fast digital signals that can corrupt measurements. The TMP461-EP device has a built-in, 65kHz filter on the D+ and D– inputs to minimize the effects of noise. However, a bypass capacitor placed differentially across the inputs of the remote temperature sensor is recommended to make the application more robust against unwanted coupled signals. For this capacitor, select a value between 100pF differential and 1nF. Some

applications attain better overall accuracy with additional series resistance. However, this increased accuracy is application-specific. When series resistance is added, the total value must not be greater than 1k Ω . If filtering is required, suggested component values are 100pF differential and 50 Ω on each input; exact values are application-specific.

Additionally, a digital filter is available for the remote temperature measurements to reduce the effect of noise further. This filter is programmable and has two levels when enabled. Level 1 performs a moving average of four consecutive samples. Level 2 performs a moving average of eight consecutive samples. Level 1 filtering can be achieved by setting the digital filter control register (read address 24h, write address 24h) to 01h. Level 2 filtering can be achieved by setting the digital filter control register (read address 24h, write address 24h) to 02h. The value stored in the remote temperature result register is the output of the digital filter, and is the value that the $\overline{\text{ALERT}}$ and $\overline{\text{THERM}}$ limits are compared to. The digital filter provides additional immunity to noise and spikes on the $\overline{\text{ALERT}}$ and $\overline{\text{THERM}}$ outputs. The filter responses to impulse and step inputs are shown in [Figure 7-2](#) and [Figure 7-3](#), respectively. The filter can be enabled or disabled by programming the desired levels in the digital filter register; see [Table 8-1](#). The digital filter is disabled by default and on POR.

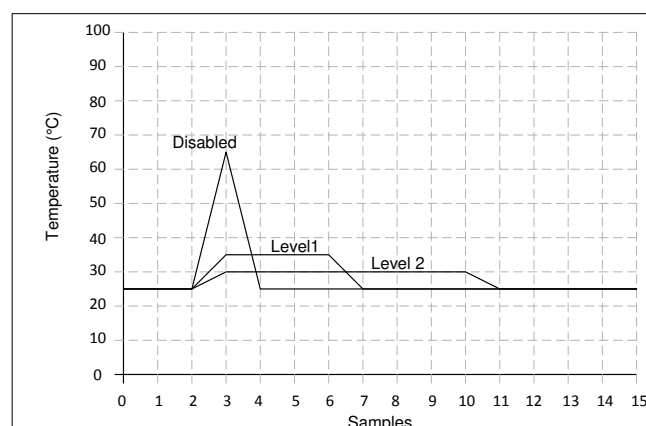


Figure 7-2. Filter Response to Impulse Inputs

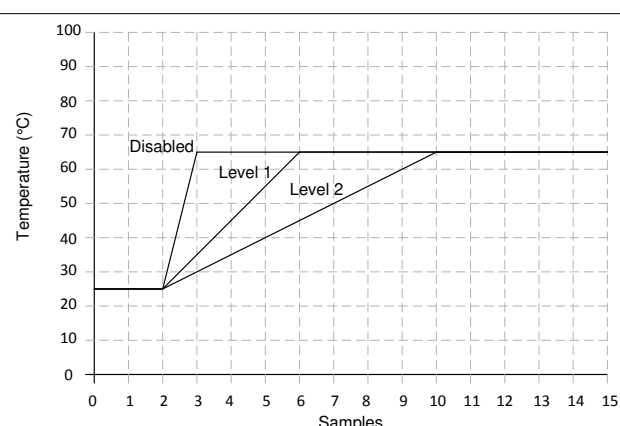


Figure 7-3. Filter Response to Step Inputs

7.3.5 Sensor Fault

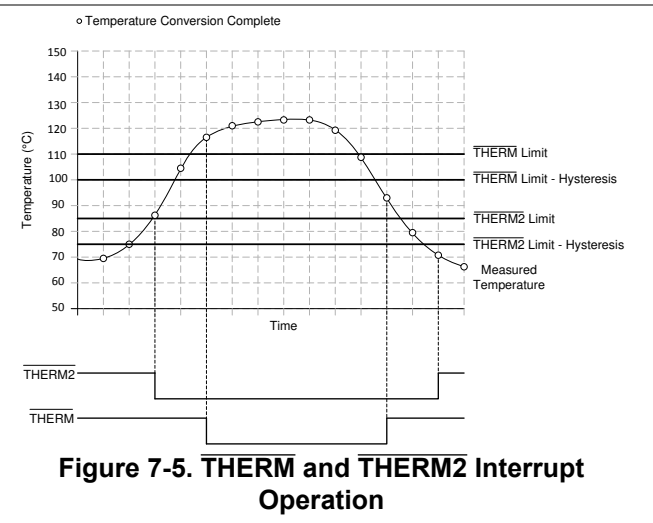
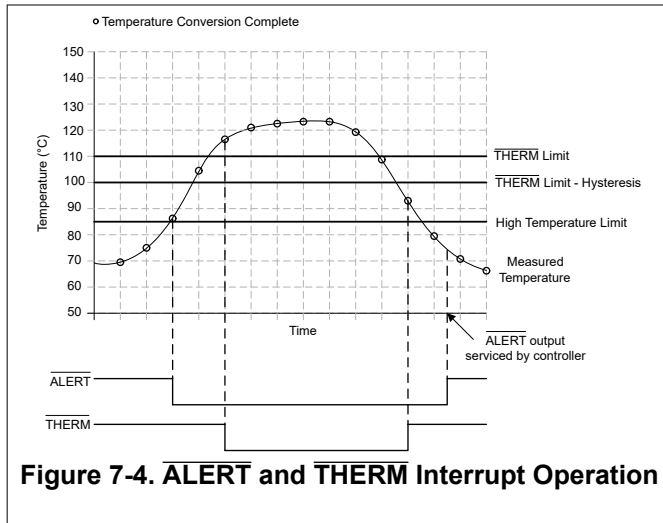
The TMP461-EP device can sense a fault at the D+ input resulting from an incorrect diode connection. The TMP461-EP device can also sense an open circuit. Short-circuit conditions return a value of -64°C . The detection circuitry consists of a voltage comparator that trips when the voltage at D+ exceeds $(V+) - 0.3\text{V}$ (typical). The comparator output is continuously checked during a conversion. If a fault is detected, then OPEN (bit 2) in the status register is set to 1.

When not using the remote sensor with the TMP461-EP device, D+ must be connected to D– or GND to prevent meaningless fault warnings.

7.3.6 $\overline{\text{ALERT}}$ and $\overline{\text{THERM}}$ Functions

Operation of the $\overline{\text{ALERT}}$ (pin 10) and $\overline{\text{THERM}}$ (pin 7) interrupts is shown in [Figure 7-4](#). Operation of the $\overline{\text{THERM}}$ (pin 7) and $\overline{\text{THERM2}}$ (pin 10) interrupts is shown in [Figure 7-5](#). The $\overline{\text{ALERT}}$ and $\overline{\text{THERM}}$ pin setting is determined by bit 5 of the configuration register.

The hysteresis value is stored in the $\overline{\text{THERM}}$ hysteresis register and applies to both the $\overline{\text{THERM}}$ and $\overline{\text{THERM2}}$ interrupts. The value of the CONAL[2:0] bits in the consecutive $\overline{\text{ALERT}}$ register (see [Table 8-1](#)) determines the number of limit violations before the $\overline{\text{ALERT}}$ pin is tripped. The default value is 000b and corresponds to one violation, 001b programs two consecutive violations, 011b programs three consecutive violations, and 111b programs four consecutive violations. The CONAL[2:0] bits provide additional filtering for the $\overline{\text{ALERT}}$ pin state.



7.4 Device Functional Modes

7.4.1 Shutdown Mode (SD)

The TMP461-EP shutdown mode enables the user to save maximum power by shutting down all device circuitry other than the serial interface, and reducing current consumption to typically less than 3μA; see [Figure 6-10](#) (*Shutdown Quiescent Current vs Supply Voltage*). Shutdown mode is enabled when the SD bit (bit 6) of the configuration register is high; the device shuts down after the current conversion is finished. When the SD bit is low, the device maintains a continuous-conversion state.

7.5 Programming

7.5.1 Serial Interface

The TMP461-EP device operates only as a target device on either the two-wire bus or the SMBus. Connections to either bus are made using the open-drain I/O lines, SDA and SCL. The SDA and SCL pins feature integrated spike suppression filters and Schmitt triggers to minimize the effects of input spikes and bus noise. The TMP461-EP device supports the transmission protocol for fast (1kHz to 400kHz), fast-plus (1kHz to 1MHz) and high-speed (1kHz to 2.17MHz) modes. All data bytes are transmitted MSB first.

7.5.1.1 Bus Overview

The TMP461-EP device is SMBus-interface-compatible. In the SMBus protocol, the device that initiates the transfer is called a *controller*, and the devices controlled by the controller are *targets*. The bus must be controlled by a controller device that generates the serial clock (SCL), controls the bus access, and generates the start and stop conditions.

To address a specific device, a start condition is initiated. A start condition is indicated by pulling the data line (SDA) from a high-to-low logic level when SCL is high. All targets on the bus shift in the target address byte, with the last bit indicating whether a read or write operation is intended. During the ninth clock pulse, the target being addressed responds to the controller by generating an *acknowledge* bit and pulling SDA low.

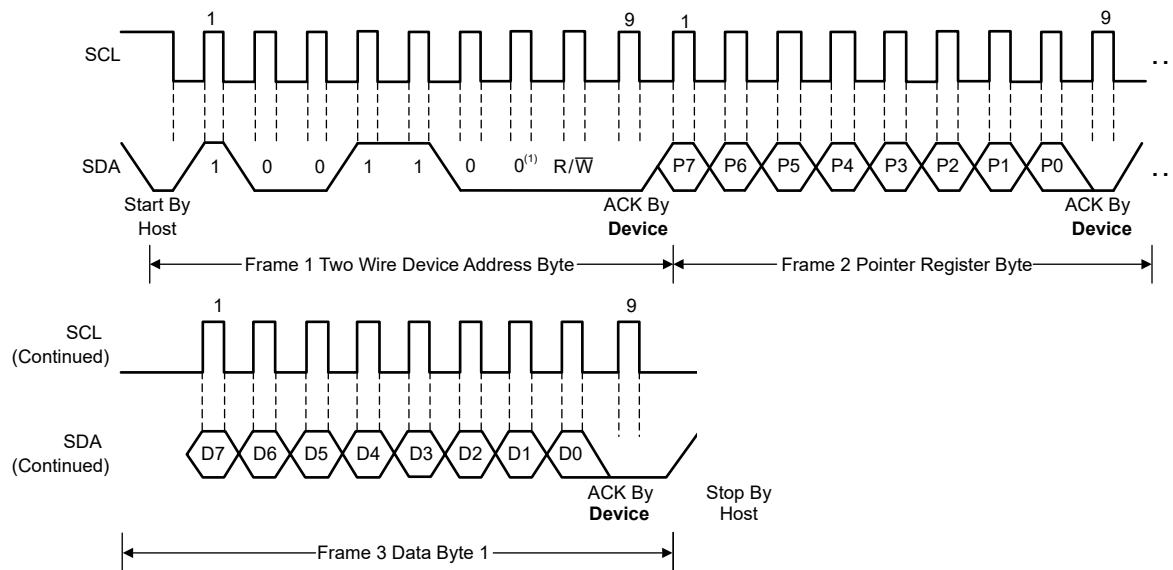
Data transfer is then initiated and sent over eight clock pulses, followed by an acknowledge bit. During data transfer, SDA must remain stable when SCL is high. A change in SDA when SCL is high is interpreted as a control signal.

After all data is transferred, the controller generates a stop condition. A stop condition is indicated by pulling SDA from low to high when SCL is high.

7.5.1.2 Bus Definitions

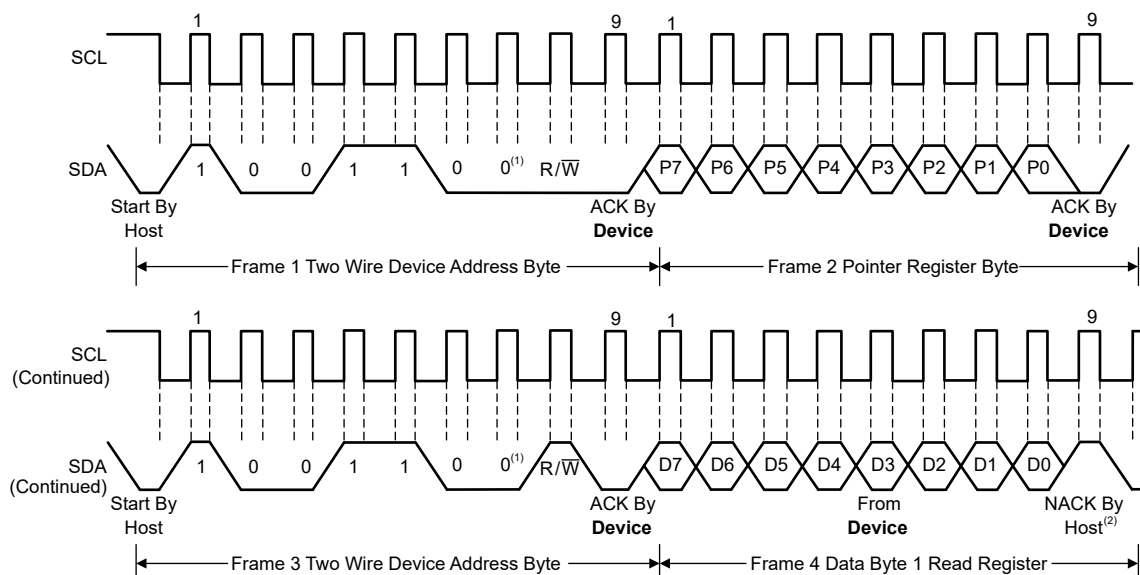
The TMP461-EP device is two-wire- and SMBus-compatible. [Figure 7-6](#) and [Figure 7-7](#) illustrate the timing for various operations on the TMP461-EP device. The bus definitions are as follows:

Bus Idle:	Both SDA and SCL lines remain high.
Start Data Transfer:	A change in the state of the SDA line (from high to low) when the SCL line is high defines a start condition. Each data transfer initiates with a start condition.
Stop Data Transfer:	A change in the state of the SDA line (from low to high) when the SCL line is high defines a stop condition. Each data transfer terminates with a repeated start or stop condition.
Data Transfer:	The number of data bytes transferred between a start and stop condition is not limited and is determined by the controller device. The receiver acknowledges the data transfer.
Acknowledge:	Each receiving device, when addressed, is obliged to generate an acknowledge bit. A device that acknowledges must pull down the SDA line during the acknowledge clock pulse in such a way that the SDA line is stable low during the high period of the acknowledge clock pulse. Take setup and hold times into account. On a controller receive, data transfer termination can be signaled by the controller generating a not-acknowledge on the last byte that is transmitted by the target.



A. Target address 1001100 is shown.

Figure 7-6. Two-Wire Timing Diagram for Write Word Format



- A. Target address 1001100 is shown.
B. The controller must leave SDA high to terminate a single-byte read operation.

Figure 7-7. Two-Wire Timing Diagram for Single-Byte Read Format

7.5.1.3 Serial Bus Address

To communicate with the TMP461-EP device, the controller must first address target devices using a target address byte. The target address byte consists of seven address bits and a direction bit indicating the intent of executing a read or write operation. The TMP461-EP allows up to nine devices to be connected to the SMBus, depending on the A0, A1 pin connections as described in [Table 7-5](#). The A0 and A1 address pins must be isolated from noisy or high-frequency signals traces to avoid false address settings when these pins are set to a float state.

Table 7-5. TMP461-EP Target Address Options

A1 CONNECTION	A0 CONNECTION	TARGET ADDRESS	
		BINARY	HEX
GND	GND	1001 000	48
GND	Float	1001 001	49
GND	V+	1001 010	4A
Float	GND	1001 011	4B
Float	Float	1001 100	4C
Float	V+	1001 101	4D
V+	GND	1001 110	4E
V+	Float	1001 111	4F
V+	V+	1010 000	50

7.5.1.4 Read and Write Operations

Accessing a particular register on the TMP461-EP device is accomplished by writing the appropriate value to the pointer register. The value for the pointer register is the first byte transferred after the target address byte with the $\overline{R/W}$ bit low. Every write operation to the TMP461-EP device requires a value for the pointer register (see [Figure 7-6](#)).

When reading from the TMP461-EP device, the last value stored in the pointer register by a write operation is used to determine which register is read by a read operation. To change which register is read for a read

operation, a new value must be written to the pointer register. This transaction is accomplished by issuing a target address byte with the R/W bit low, followed by the pointer register byte; no additional data are required. The controller can then generate a start condition and send the target address byte with the R/W bit high to initiate the read command; see [Figure 7-7](#) for details of this sequence.

If repeated reads from the same register are desired, continually sending the pointer register bytes is not necessary because the TMP461-EP retains the pointer register value until the value is changed by the next write operation. The register bytes are sent MSB first, followed by the LSB.

Terminate read operations by issuing a *not-acknowledge* command at the end of the last byte to be read. For a single-byte operation, the controller must leave the SDA line high during the acknowledge time of the first byte that is read from the target.

7.5.1.5 Timeout Function

The TMP461-EP device resets the serial interface if either SCL or SDA is held low for 25ms (typical) between a start and stop condition. If the TMP461-EP device is holding the bus low, the device releases the bus and waits for a start condition. To avoid activating the timeout function, maintaining a communication speed of at least 1kHz for the SCL operating frequency is necessary.

7.5.1.6 High-Speed Mode

For the two-wire bus to operate at frequencies above 1MHz, the controller device must issue a high-speed mode (HS-mode) controller code (0000 1xxx) as the first byte after a start condition to switch the bus to high-speed operation. The TMP461-EP device does not acknowledge this byte, but switches the input filters on SDA and SCL and the output filter on SDA to operate in HS-mode, thus allowing transfers at up to 2.17MHz. After the HS-mode controller code is issued, the controller transmits a two-wire target address to initiate a data transfer operation. The bus continues to operate in HS-mode until a stop condition occurs on the bus. Upon receiving the stop condition, the TMP461-EP device switches the input and output filters back to fast mode operation.

7.5.2 General-Call Reset

The TMP461-EP device supports reset using the two-wire general-call address 00h (0000 0000b). The TMP461-EP device acknowledges the general-call address and responds to the second byte. If the second byte is 06h (0000 0110b), the TMP461-EP device executes a software reset. This software reset restores the power-on reset state to all TMP461-EP registers and aborts any conversion in progress. The TMP461-EP device takes no action in response to other values in the second byte.

8 Register Map

Table 8-1. Register Map

POINTER READ (HEX)	POINTER WRITE (HEX)	POR (HEX)	BIT DESCRIPTION								REGISTER DESCRIPTION
			7	6	5	4	3	2	1	0	
00	N/A	00	LT11	LT10	LT9	LT8	LT7	LT6	LT5	LT4	Local Temperature Register (high byte)
01	N/A	00	RT11	RT10	RT9	RT8	RT7	RT6	RT5	RT4	Remote Temperature Register (high byte)
02	N/A	N/A	BUSY	LHIGH	LLOW	RHIGH	RLOW	OPEN	RTHRM	LTHRM	Status Register
03	09	00	MASK1	SD	ALERT/ THERM2	0	0	RANGE	0	0	Configuration Register
04	0A	08	0	0	0	0	CR3	CR2	CR1	CR0	Conversion Rate Register
05	0B	7F	LTHL11	LTHL10	LTHL9	LTHL8	LTHL7	LTHL6	LTHL5	LTHL4	Local Temperature High Limit Register
06	0C	80	LTLL11	LTLL10	LTLL9	LTLL8	LTLL7	LTLL6	LTLL5	LTLL4	Local Temperature Low Limit Register
07	0D	7F	RTHL11	RTHL10	RTHL9	RTHL8	RTHL7	RTHL6	RTHL5	RTHL4	Remote Temperature High Limit Register (high byte)
08	0E	80	RTLL11	RTLL10	RTLL9	RTLL8	RTLL7	RTLL6	RTLL5	RTLL4	Remote Temperature Low Limit Register (high byte)
N/A	0F	N/A	X	X	X	X	X	X	X	X	One-Shot Start Register ⁽¹⁾
10	N/A	00	RT3	RT2	RT1	RT0	0	0	0	0	Remote Temperature Register (low byte)
11	11	00	RTOS11	RTOS10	RTOS9	RTOS8	RTOS7	RTOS6	RTOS5	RTOS4	Remote Temperature Offset Register (high byte)
12	12	00	RTOS3	RTOS2	RTOS1	RTOS0	0	0	0	0	Remote Temperature Offset Register (low byte)
13	13	F0	RTHL3	RTHL2	RTHL1	RTHL0	0	0	0	0	Remote Temperature High Limit Register (low byte)
14	14	00	RTLL3	RTLL2	RTLL1	RTLL0	0	0	0	0	Remote Temperature Low Limit Register (low byte)
15	N/A	00	LT3	LT2	LT1	LT0	0	0	0	0	Local Temperature Register (low byte)
16	16	03	0	0	0	0	0	0	REN	LEN	Channel Enable Register
19	19	7F	RTH11	RTH10	RTH9	RTH8	RTH7	RTH6	RTH5	RTH4	Remote Temperature THERM Limit Register
20	20	7F	LTH11	LTH10	LTH9	LTH8	LTH7	LTH6	LTH5	LTH4	Local Temperature THERM Limit Register
21	21	0A	HYS11	HYS10	HYS9	HYS8	HYS7	HYS6	HYS5	HYS4	THERM Hysteresis Register
22	22	01	0	0	0	0	CONAL2	CONAL1	CONAL0	1	Consecutive ALERT Register
23	23	00	NC7	NC6	NC5	NC4	NC3	NC2	NC1	NC0	η-Factor Correction Register
24	24	00	0	0	0	0	0	0	DF1	DF0	Digital Filter Control Register
FE	N/A	55	0	1	0	1	0	1	0	1	Manufacturer Identification Register

(1) X = undefined. Writing any value to this register initiates a one-shot start; see the [One-Shot Conversion](#) section.

8.1 Register Information

The TMP461-EP device contains multiple registers for holding configuration information, temperature measurement results, and status information. These registers are described in [Figure 8-1](#) and [Table 8-1](#).

8.1.1 Pointer Register

[Figure 8-1](#) shows the internal register structure of the TMP461-EP device. The 8-bit pointer register is used to address a given data register. The pointer register identifies which of the data registers must respond to a read or write command on the two-wire bus. This register is set with every write command. A write command must be issued to set the proper value in the pointer register before executing a read command. [Table 8-1](#) describes the pointer register and the internal structure of the TMP461-EP registers. The power-on reset (POR) value of the pointer register is 00h (0000 0000b).

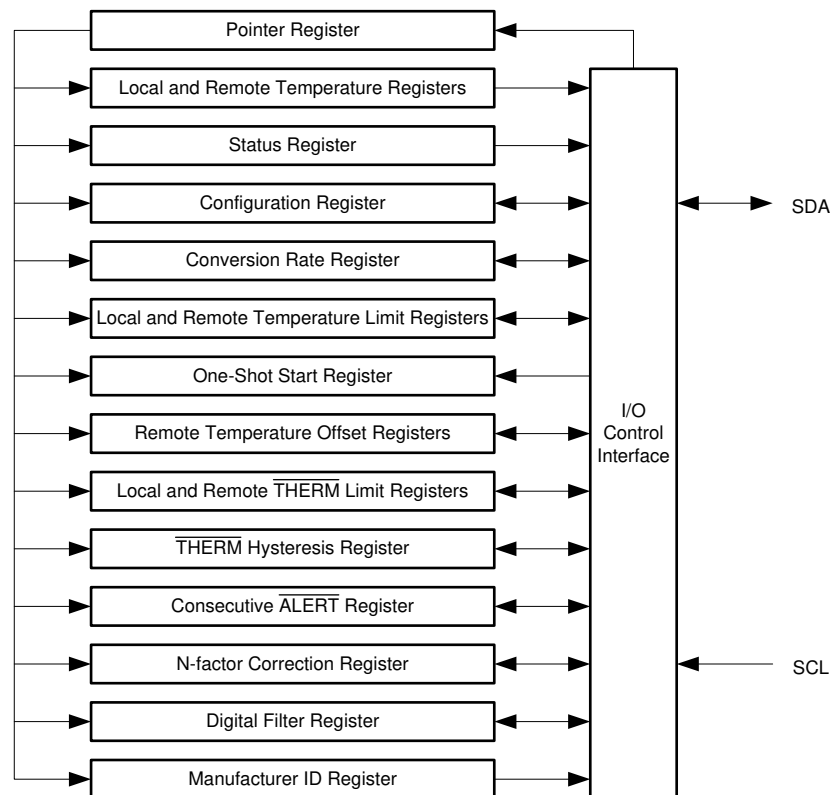


Figure 8-1. Internal Register Structure

8.1.2 Local and Remote Temperature Registers

The TMP461-EP device has multiple 8-bit registers that hold temperature measurement results. The eight most significant bits (MSBs) of the local temperature sensor result are stored in register 00h, and the four least significant bits (LSBs) are stored in register 15h (the four MSBs of register 15h). The eight MSBs of the remote temperature sensor result are stored in register 01h, and the four LSBs are stored in register 10h (the four MSBs of register 10h). The four LSBs of both the local and remote sensor indicate the temperature value after the decimal point (for example, if the temperature result is 10.0625°C, then the high byte is 0000 1010 and the low byte is 0001 0000). These registers are read-only and are updated by the ADC each time a temperature measurement is completed.

When the full temperature value is needed, reading the MSB value first causes the LSB value to be locked (the ADC does not write to the value) until the LSB value is read. The same thing happens upon reading the LSB value first (the MSB value is locked until the value is read). This mechanism verifies that both bytes of the read operation are from the same ADC conversion. This assurance remains valid only until another register is read. For proper operation, read the high byte of the temperature result first. Read the low byte register in the next

read command; if the LSBs are not needed, the register can be left unread. The power-on reset value of all temperature registers is 00h.

8.1.3 Status Register

The status register reports the state of the temperature ADC, the temperature limit comparators, and the connection to the remote sensor. Table 8-2 lists the status register bits. The status register is read-only and is read by accessing the pointer address 02h.

Table 8-2. Status Register Format

STATUS REGISTER (Read = 02h, Write = N/A)		
BIT NUMBER	BIT NAME	FUNCTION
7	BUSY	= 1 when the ADC is converting
6	LHIGH ⁽¹⁾	= 1 when the local high temperature limit is tripped
5	LLOW ⁽¹⁾	= 1 when the local low temperature limit is tripped
4	RHIGH ⁽¹⁾	= 1 when the remote high temperature limit is tripped
3	RLOW ⁽¹⁾	= 1 when the remote low temperature limit is tripped
2	OPEN ⁽¹⁾	= 1 when the remote sensor is an open circuit
1	RTHRM	= 1 when the remote THERM limit is tripped
0	LTHRM	= 1 when the local THERM limit is tripped

- (1) These flags stay high until the status register is read or are reset by a POR when pin 10 is configured as $\overline{\text{ALERT}}$. Only bit 2 (OPEN) stays high until the status register is read or is reset by a POR when pin 10 is configured as THERM2.

The BUSY bit = 1 if the ADC is making a conversion. This bit is set to 0 if the ADC is not converting.

The LHIGH and LLOW bits indicate a local sensor overtemperature or undertemperature event, respectively. The RHIGH and RLOW bits indicate a remote sensor overtemperature or undertemperature event, respectively. The HIGH bit is set when the temperature exceeds the high limit in alert mode and therm mode, and the low bit is set when the temperature goes below the low limit in alert mode. The OPEN bit indicates an open-circuit condition on the remote sensor. When pin 10 is configured as the $\overline{\text{ALERT}}$ output, the five flags are NORed together. If any of the five flags are high, the $\overline{\text{ALERT}}$ interrupt latch is set and the $\overline{\text{ALERT}}$ output goes low. Reading the status register clears the five flags, provided that the condition that caused the setting of the flags is not present anymore (that is, the value of the corresponding result register is within the limits, or the remote sensor is connected properly and functional). The $\overline{\text{ALERT}}$ interrupt latch (and the $\overline{\text{ALERT}}$ pin correspondingly) is not reset by reading the status register. The reset is done by the controller reading the temperature sensor device address to service the interrupt, and only if the flags are reset and the condition that caused them to be set is no longer present.

The RTHRM and LTHRM flags are set when the corresponding temperature exceeds the programmed THERM limit. These flags are reset automatically when the temperature returns to within the limits. The THERM output goes low in the case of overtemperature on either the local or remote channel, and goes high as soon as the measurements are within the limits again. The THERM hysteresis register (21h) allows hysteresis to be added so that the flag resets and the output goes high when the temperature returns to or goes below the limit value minus the hysteresis value.

When pin 10 is configured as THERM2, only the high limits matter. The LHIGH and RHIGH flags are set if the respective temperatures exceed the limit values, and the pin goes low to indicate the event. The LLOW and RLOW flags have no effect on THERM2, and the output behaves the same way when configured as THERM.

8.1.4 Configuration Register

The configuration register sets the temperature range, the $\overline{\text{ALERT}}$ / THERM modes, and controls the shutdown mode. The configuration register is set by writing to pointer address 09h, and is read by reading from pointer address 03h. Table 8-3 summarizes the bits of the configuration register.

Table 8-3. Configuration Register Bit Descriptions

CONFIGURATION REGISTER (Read = 03h, Write = 09h, POR = 00h)			
BIT NUMBER	NAME	FUNCTION	POWER-ON RESET VALUE
7	MASK1	0 = $\overline{\text{ALERT}}$ enabled 1 = $\overline{\text{ALERT}}$ masked	0
6	SD	0 = Run 1 = Shut down	0
5	$\overline{\text{ALERT}}/\text{THERM2}$	0 = $\overline{\text{ALERT}}$ 1 = $\overline{\text{THERM2}}$	0
4:3	Reserved	—	0
2	RANGE	0 = -40°C to $+127^{\circ}\text{C}$ 1 = -64°C to $+191^{\circ}\text{C}$	0
1:0	Reserved	—	0

MASK1 (bit 7) of the configuration register masks the $\overline{\text{ALERT}}$ output. If MASK1 is 0 (default), the $\overline{\text{ALERT}}$ output is enabled. If MASK1 is set to 1, the $\overline{\text{ALERT}}$ output is disabled. This configuration applies only if the value of $\overline{\text{ALERT}}/\text{THERM2}$ (bit 5) is 0 (that is, pin 10 is configured as the $\overline{\text{ALERT}}$ output). If pin 10 is configured as the $\overline{\text{THERM2}}$ output, the value of the MASK1 bit has no effect.

The shutdown bit (SD, bit 6) enables or disables the temperature-measurement circuitry. If SD = 0 (default), the TMP461-EP device converts continuously at the rate set in the conversion rate register. When SD is set to 1, the TMP461-EP device stops converting when the current conversion sequence is complete and enters a shutdown mode. When SD is set to 0 again, the TMP461-EP resumes continuous conversions. When SD = 1, a single conversion can be started by writing to the one-shot start register; see the [One-Shot Start Register](#) section for more information.

$\overline{\text{ALERT}}/\text{THERM2}$ (bit 5) sets the configuration of pin 10. If the $\overline{\text{ALERT}}/\text{THERM2}$ bit is 0 (default), then pin 10 is configured as the $\overline{\text{ALERT}}$ output; if this bit is set to 1, then pin 10 is configured as the $\overline{\text{THERM2}}$ output.

The temperature range is set by configuring RANGE (bit 2) of the configuration register. Setting this bit low (default) configures the TMP461-EP device for the standard measurement range (-40°C to $+127^{\circ}\text{C}$); temperature conversions are stored in the standard binary format. Setting bit 2 high configures the TMP461-EP device for the extended measurement range (-64°C to $+191^{\circ}\text{C}$); temperature conversions are stored in the extended binary format (see [Table 7-1](#)). The remaining bits of the configuration register are reserved and must always be set to 0. The power-on reset value for this register is 00h.

8.1.5 Conversion Rate Register

The conversion rate register (read address 04h, write address 0Ah) controls the rate at which temperature conversions are performed. This register adjusts the idle time between conversions but not the conversion time, thereby allowing the TMP461-EP power dissipation to be balanced with the temperature register update rate. [Table 8-4](#) lists the conversion rate options and corresponding time between conversions. The default value of the register is 08h, which gives a default rate of 16 conversions per second.

Table 8-4. Conversion Rate

VALUE	CONVERSIONS PER SECOND	TIME (SECONDS)
00h	0.0625	16
01h	0.125	8
02h	0.25	4
03h	0.5	2
04h	1	1
05h	2	0.5
06h	4	0.25
07h	8	0.125
08h	16 (default)	0.0625 (default)

Table 8-4. Conversion Rate (continued)

VALUE	CONVERSIONS PER SECOND	TIME (SECONDS)
09h	32	0.03125

8.1.6 One-Shot Start Register

When the TMP461-EP device is in shutdown mode (SD = 1 in the configuration register), a single conversion is started by writing any value to the one-shot start register, pointer address 0Fh. This write operation starts one conversion and comparison cycle on either both the local and remote sensors or on only one or the other sensor, depending on the LEN and REN values configured in the channel enable register (read address 16h, write address 16h). The TMP461-EP device returns to shutdown mode when the cycle completes. The value of the data sent in the write command is irrelevant and is not stored by the TMP461-EP device.

8.1.7 Channel Enable Register

The channel enable register (read address 16h, write address 16h) enables or disables the temperature conversion of remote and local temperature sensors. LEN (bit 0) of the channel enable register enables/disables the conversion of local temperature. REN (bit 1) of the channel enable register enables/disables the conversion of remote temperature. Both LEN and REN are set to 1 (default), which enables the ADC to convert both local and remote temperatures. If LEN is set to 0, the local temperature conversion is disabled, and similarly, if REN is set to 0, the remote temperature conversion is disabled.

Both local and remote temperatures are converted by the internal ADC as a default mode. The Channel Enable register can be configured to achieve power savings by reducing the total ADC conversion time to half for applications that do not require both remote and local temperature information.

8.1.8 Consecutive $\overline{\text{ALERT}}$ Register

The Consecutive $\overline{\text{ALERT}}$ register (read address 22h, write address 22h) controls the number of out-of-limit temperature measurements required for $\overline{\text{ALERT}}$ to be asserted. [Table 8-5](#) summarizes the values of the consecutive $\overline{\text{ALERT}}$ register. The number programmed in the consecutive $\overline{\text{ALERT}}$ applies to both the remote and local temperature results. When the number of times that the temperature result consecutively exceeds the high limit register value is equal to the value programmed in the consecutive $\overline{\text{ALERT}}$ register, $\overline{\text{ALERT}}$ is asserted. Similarly, the consecutive $\overline{\text{ALERT}}$ register setting is also applicable to the low-limit register.

Table 8-5. Consecutive $\overline{\text{ALERT}}$

REGISTER VALUE	NUMBER OF OUT-OF-LIMIT MEASUREMENTS REQUIRED TO ASSERT $\overline{\text{ALERT}}$
01h	1 (default)
03h	2
07h	3
0Fh	4

8.1.9 η -Factor Correction Register

The TMP461-EP device allows for a different η -factor value to be used for converting remote channel measurements to temperature. The remote channel uses sequential current excitation to extract a differential V_{BE} voltage measurement to determine the temperature of the remote transistor. [Equation 1](#) shows this voltage and temperature.

$$V_{\text{BE}2} - V_{\text{BE}1} = \frac{\eta k T}{q} \ln \left(\frac{I_2}{I_1} \right) \quad (1)$$

The value η in [Equation 1](#) is a characteristic of the particular transistor used for the remote channel. The power-on reset value for the TMP461-EP device is $\eta = 1.008$. The value in the η -factor correction register can be used to adjust the effective η -factor according to [Equation 2](#) and [Equation 3](#).

$$\eta_{\text{eff}} = \left(\frac{1.008 \times 2088}{2088 + N_{\text{ADJUST}}} \right) \quad (2)$$

$$N_{\text{ADJUST}} = \left(\frac{1.008 \times 2088}{\eta_{\text{eff}}} \right) - 2088 \quad (3)$$

The η -factor correction value must be stored in 2's complement format, yielding an effective data range from –128 to 127. The η -factor correction value is written to and read from pointer address 23h. The register power-on reset value is 00h, thus having no effect unless a different value is written to the register. The resolution of the η -factor register is 0.000483.

Table 8-6. η -Factor Range

N _{ADJUST}			η
BINARY	HEX	DECIMAL	
0111 1111	7F	127	0.950205
0000 1010	0A	10	1.003195
0000 1000	08	8	1.004153
0000 0110	06	6	1.005112
0000 0100	04	4	1.006073
0000 0010	02	2	1.007035
0000 0001	01	1	1.007517
0000 0000	00	0	1.008
1111 1111	FF	–1	1.008483
1111 1110	FE	–2	1.008966
1111 1100	FC	–4	1.009935
1111 1010	FA	–6	1.010905
1111 1000	F8	–8	1.011877
1111 0110	F6	–10	1.012851
1000 0000	80	–128	1.073829

8.1.10 Remote Temperature Offset Register

The offset register allows the TMP461-EP device to store any system offset compensation value that can result from precision calibration. The value in the register is stored in the same format as the temperature result and is added to the remote temperature result upon every conversion. Combined with the η -factor correction, this function allows for very accurate system calibration over the entire temperature range.

8.1.11 Manufacturer Identification Register

The TMP461-EP device allows for the two-wire bus controller to query the device for manufacturer and device IDs to enable software identification of the device at the particular two-wire bus address. The manufacturer ID is obtained by reading from the pointer address FEh. The TMP461-EP device reads 55h for the manufacturer code.

Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

The TMP461-EP device requires only a transistor connected between the D+ and D– pins for remote temperature measurement. Tie the D+ pin to D– or GND if the remote channel is not used and only the local temperature is measured. The SDA, $\overline{\text{ALERT}}$, and $\overline{\text{THERM}}$ pins (and SCL, if driven by an open-drain output) require pullup resistors as part of the communication bus. A 0.1 μF power-supply decoupling capacitor is recommended for local bypassing. [Figure 9-1](#) and [Figure 9-2](#) show the typical configurations for the TMP461-EP device.

Figure 1: Typical connection of the TMP461-EP. The diagram shows the TMP461-EP chip connected to an SMBus Controller and a power supply (1.7V to 3.6V). The chip has pins for SDA (1), SCL (2), A1 (3), V+ (4), D+ (5), ALERT/ THERM2 (10), GND (9), A0 (8), THERM (7), and D- (6). The chip is connected to an SMBus Controller via SDA and SCL. The V+ pin is connected to the 1.7V to 3.6V supply. The D+ and D- pins are connected to a built-in thermal transistor or diode, which is connected to GND. The ALERT/ THERM2 pin is connected to a pull-up resistor to the 1.7V to 3.6V supply. The THERM pin is connected to a pull-up resistor to the 1.7V to 3.6V supply. The A0 and A1 pins are connected to GND. The chip is also connected to a PNP Diode-connected configuration (A) and an NPN Diode-connected configuration (A).

- A. A diode-connected configuration provides better settling time. The transistor-connected configuration provides better series resistance cancellation. NPN transistors must be diode-connected. PNP transistors can either be transistor-connected or diode-connected. For more information on NPN/PNP transistors, see the [Remote Temperature Sensor Transistor Selection Guide](#) application note.
- B. R_s (optional) must be $< 1\text{ k}\Omega$ in most applications. Selections of R_s depend on specific applications; see the [Section 7.3.4](#)
- C. C_{DIFF} (optional) must be $< 1000\text{ pF}$ in most applications. Selections of C_{DIFF} depend on the specific application; see the [Section 7.3.4](#) and [Figure 6-6](#).

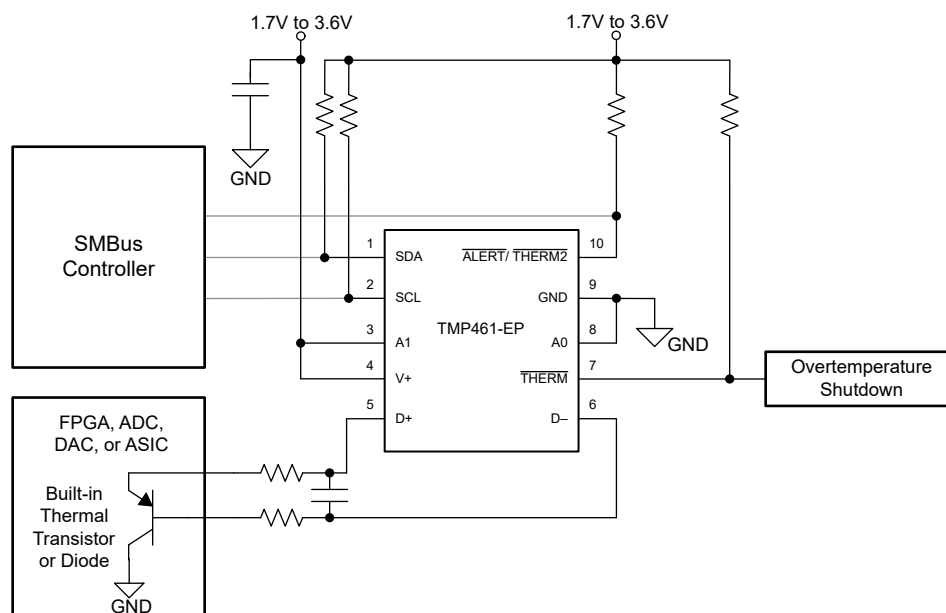


Figure 9-2. TMP461-EP Basic Connections Using a Processor Built-In Remote Transistor

9.2.1 Design Requirements

The TMP461-EP device is designed to be used with either discrete transistors or substrate transistors built into processor chips and application-specific integrated circuits (ASICs). Either NPN or PNP transistors can be used, as long as the base-emitter junction is used as the remote temperature sense. NPN transistors must be diode-connected. PNP transistors can either be transistor-connected or diode-connected (see [Figure 9-1](#)). The D+ pin waveform is shown in [Figure 9-3](#) while a transistor is connected between the D+ and D- pins. Due to three different source currents shown in [Figure 7-1](#), the D+ waveform has three levels of voltages during temperature conversion.

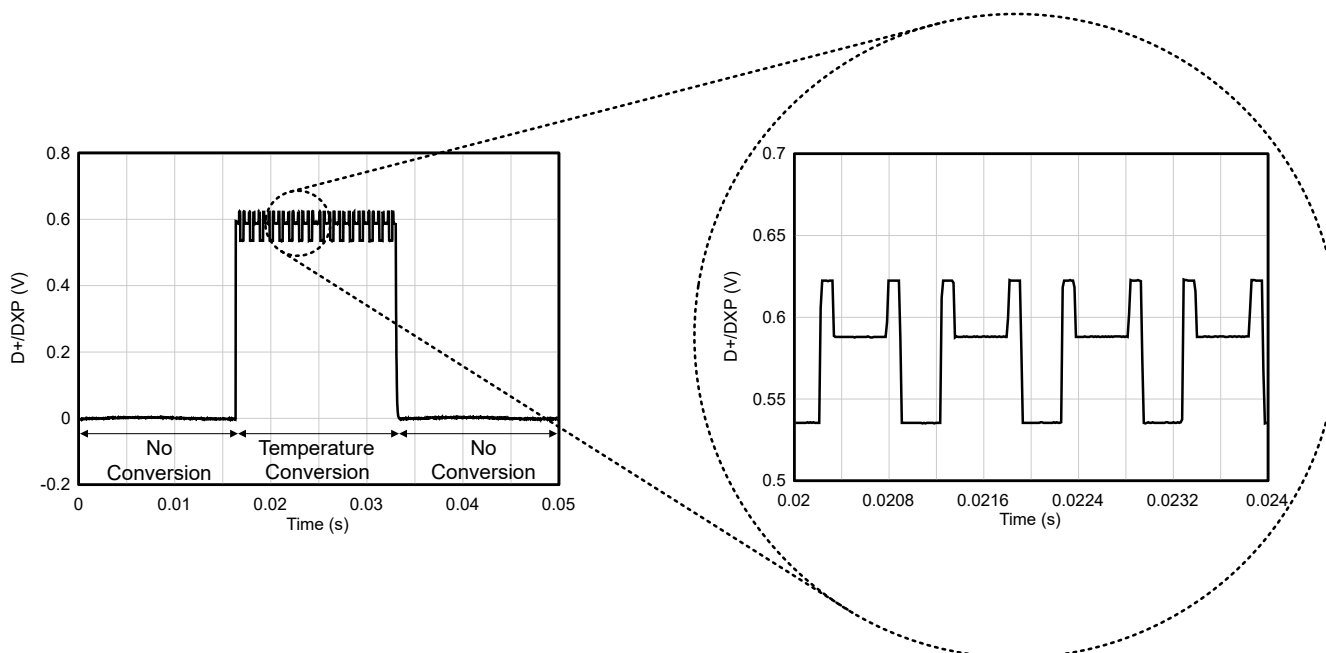


Figure 9-3. D+ Waveform

Errors in remote temperature sensor readings are typically the consequence of the ideality factor and current excitation used by the TMP461-EP device versus the manufacturer-specified operating current for a given transistor. Some manufacturers specify a high-level and low-level current for the temperature-sensing substrate transistors. The TMP461-EP device uses 7.5µA for I_{LOW} and 120µA for I_{HIGH} .

The ideality factor (η) is a measured characteristic of a remote temperature sensor diode as compared to an ideal diode. The TMP461-EP allows for different η -factor values; see the [η-Factor Correction Register](#) section.

The ideality factor for the TMP461-EP device is trimmed to be 1.008. For transistors that have an ideality factor that does not match the TMP461-EP, [Equation 4](#) can be used to calculate the temperature error.

Note

For [Equation 4](#) to be used correctly, the actual temperature (°C) must be converted to Kelvin (K).

$$T_{ERR} = \left(\frac{\eta - 1.008}{1.008} \right) \times (273.15 + T(^{\circ}C)) \quad (4)$$

where

- T_{ERR} = error in the TMP461-EP device because $\eta \neq 1.008$,
- η = ideality factor of the remote temperature sensor,
- $T(^{\circ}C)$ = actual temperature, and

In [Equation 4](#), the degree of delta is the same for °C and K.

For $\eta = 1.004$ and $T(^{\circ}C) = 100^{\circ}C$:

$$\begin{aligned} T_{ERR} &= \left(\frac{1.004 - 1.008}{1.008} \right) \times (273.15 + 100^{\circ}C) \\ T_{ERR} &= -1.48^{\circ}C \end{aligned} \quad (5)$$

If a discrete transistor is used as the remote temperature sensor with the TMP461-EP, the best accuracy can be achieved by selecting the transistor according to the following criteria:

1. Base-emitter voltage is $> 0.25V$ at 7.5µA, at the highest-sensed temperature.
2. Base-emitter voltage is $< 0.95V$ at 120µA, at the lowest-sensed temperature.
3. Base resistance is $< 100\Omega$.
4. Tight control of V_{BE} characteristics indicated by small variations in h_{FE} (that is, 50 to 150).

Based on this criteria, two recommended small-signal transistors are the 2N3904 (NPN) or 2N3906 (PNP).

9.2.2 Detailed Design Procedure

The local temperature sensor inside the TMP461-EP device monitors the ambient air around the device. The thermal time constant for the TMP461-EP device is approximately 1.1 seconds. This constant implies that if the ambient air changes quickly by 100°C, then the TMP461-EP device takes approximately 5.5 seconds (that is, five thermal time constants) to settle to within 1°C of the final value. In most applications, the TMP461-EP package is in electrical, and therefore thermal, contact with the printed circuit board (PCB), as well as subjected to forced airflow. The accuracy of the measured temperature directly depends on how accurately the PCB and forced airflow temperatures represent the temperature that the TMP461-EP is measuring. Additionally, the internal power dissipation of the TMP461-EP can cause the temperature to rise above the ambient or PCB temperature. The internal power dissipated as a result of exciting the remote temperature sensor is negligible because of the small currents used. [Equation 6](#) can be used to calculate the average conversion current for power dissipation and self-heating based on the number of conversions per second and the temperature sensor channel enabled. [Equation 7](#) shows an example with local and remote sensor channels enabled and 16

conversions per second; see the [Section 6.5](#) table for typical values required for these calculations. For a 3.3V supply and a conversion rate of 16 conversions per second, the TMP461-EP device dissipates 0.531mW ($P_{DIQ} = 3.3V \times 161\mu A$) when both the remote and local channels are enabled.

$$\begin{aligned} \text{Average Conversion Current} = & (\text{Local ADC Conversion Time}) \times (\text{Conversions per Second}) \times (\text{Local Active } I_Q) \\ & + (\text{Remote ADC Conversion Time}) \times (\text{Conversions per Second}) \times (\text{Remote Active } I_Q) \\ & + (\text{Standby Mode } I_Q) \times \left[1 - (\text{Local ADC Conversion Time} + \text{Remote ADC Conversion Time}) \times (\text{Conversions per Second}) \right] \end{aligned} \quad (6)$$

$$\begin{aligned} \text{Average Conversion Current} = & (15 \text{ ms}) \left(\frac{16}{s} \right) \times (240 \mu A) \\ & + (15 \text{ ms}) \times \left(\frac{16}{s} \right) (400 \mu A) \\ & + (15 \mu A) \times \left[1 - (15 \text{ ms} + 15 \text{ ms}) \times \left(\frac{16}{s} \right) \right] \\ = & 161 \mu A \end{aligned} \quad (7)$$

The temperature measurement accuracy of the TMP461-EP device depends on the remote and local temperature sensor being at the same temperature as the system point being monitored. If the temperature sensor is not in good thermal contact with the part of the system being monitored, then there is a delay between the sensor response and the system changing temperature. This delay is typically not a concern for remote temperature-sensing applications that use a substrate transistor (or a small, SOT23 transistor) placed close to the device being monitored.

9.2.3 Application Curve

[Figure 9-4](#) shows the step response of the TMP461-EP to a submersion in an oil bath of 100°C from room temperature (25°C). The time-constant, or the time for the output to reach 63% of the input step, is around 1.1s for local sensors and 0.6s for the remote diode sensor. The time-constant result depends on the printed-circuit board (PCB) size that the TMP461-EP is mounted. For this test, the TMP461-EP is soldered to a two-layer PCB that measures 0.5 inches × 0.5 inches.

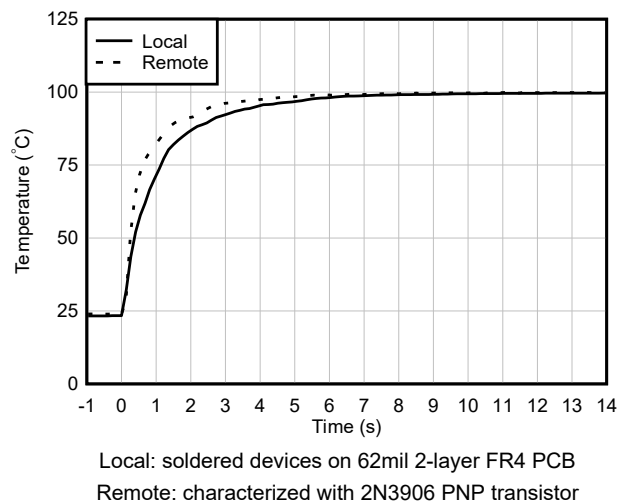


Figure 9-4. Temperature Step Response

9.3 Power Supply Recommendations

The TMP461-EP device operates with a power-supply range of 1.7V to 3.6V. The device is optimized for operation at a 3.3V supply but can measure temperature accurately in the full supply range.

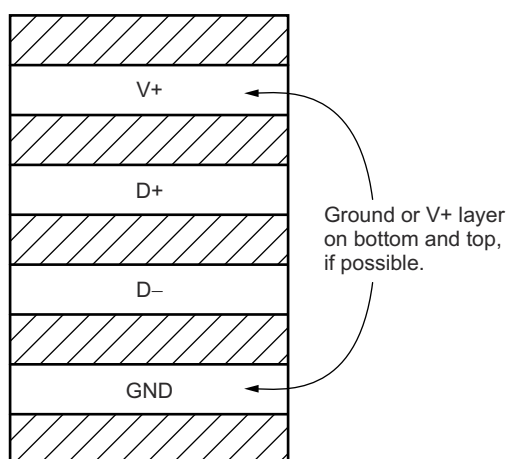
A power-supply bypass capacitor is recommended. Place this capacitor as close as possible to the supply and ground pins of the device. A typical value for this supply bypass capacitor is 0.1 μ F. Applications with noisy or high-impedance power supplies can require additional decoupling capacitors to reject power-supply noise.

9.4 Layout

9.4.1 Layout Guidelines

Remote temperature sensing on the TMP461-EP device measures very small voltages using very low currents; therefore, noise at the device inputs must be minimized. Most applications using the TMP461-EP have high digital content, with several clocks and logic-level transitions that create a noisy environment. Layout must adhere to the following guidelines:

1. Place the TMP461-EP device as close to the remote junction sensor as possible.
2. Route the D+ and D– traces next to each other and shield them from adjacent signals through the use of ground guard traces, as shown in [Figure 9-5](#). If a multilayer PCB is used, bury these traces between the ground or V+ planes to shield them from extrinsic noise sources. 5mil (0.127mm) PCB traces are recommended.
3. Minimize additional thermocouple junctions caused by copper-to-solder connections. If these junctions are used, make the same number and approximate locations of copper-to-solder connections in both the D+ and D– connections to cancel any thermocouple effects.
4. Use a 0.1 μ F local bypass capacitor directly between the V+ and GND of the TMP461-EP device. For optimum measurement performance, minimize filter capacitance between D+ and D– to 1000pF or less. This capacitance includes any cable capacitance between the remote temperature sensor and the TMP461-EP device.
5. If the connection between the remote temperature sensor and the TMP461-EP device is less than 8in (20.32cm) long, use a twisted-wire pair connection. For lengths greater than 8 in, use a twisted, shielded pair with the shield grounded as close to the TMP461-EP device as possible. Leave the remote sensor connection end of the shield wire open to avoid ground loops and 60Hz pickup.
6. Thoroughly clean and remove all flux residue in and around the pins of the TMP461-EP device to avoid temperature offset readings as a result of leakage paths between D+ and GND, or between D+ and V+.



NOTE: Use a minimum of 5mil (0.127mm) traces with 5mil spacing.

Figure 9-5. Suggested PCB Layer Cross-Section

9.4.2 Layout Example

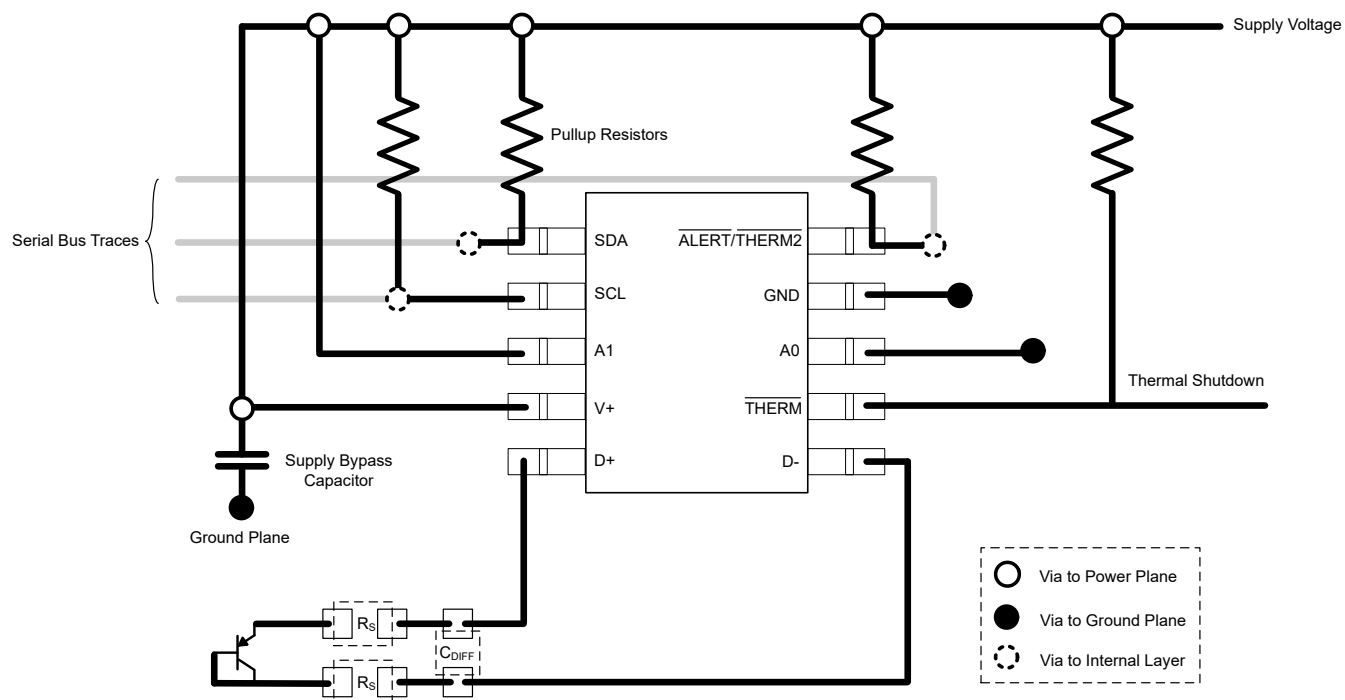


Figure 9-6. TMP461-EP Layout Example

10 Device and Documentation Support

10.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on [ti.com](https://www.ti.com). Click on *Notifications* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

10.2 Related Documentation

For related documentation see the following:

- Texas Instruments, [TMP461-SP Radiation-Hardness-Assured \(RHA\), High-Accuracy Remote and Local Temperature Sensor](#), data sheet
- Texas Instruments, [TMP461 High-Accuracy Remote and Local Temperature Sensor with Pin-Programmable Bus Address](#), data sheet
- Texas Instruments, [Remote Temperature Sensor Transistor Selection Guide](#), application note

10.3 Support Resources

TI E2E™ [support forums](#) are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

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10.4 Trademarks

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10.5 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

10.6 Glossary

[TI Glossary](#) This glossary lists and explains terms, acronyms, and definitions.

11 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

DATE	REVISION	NOTES
September 2025	*	Initial Release

12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

TAPE AND REEL INFORMATION



*All dimensions are nominal

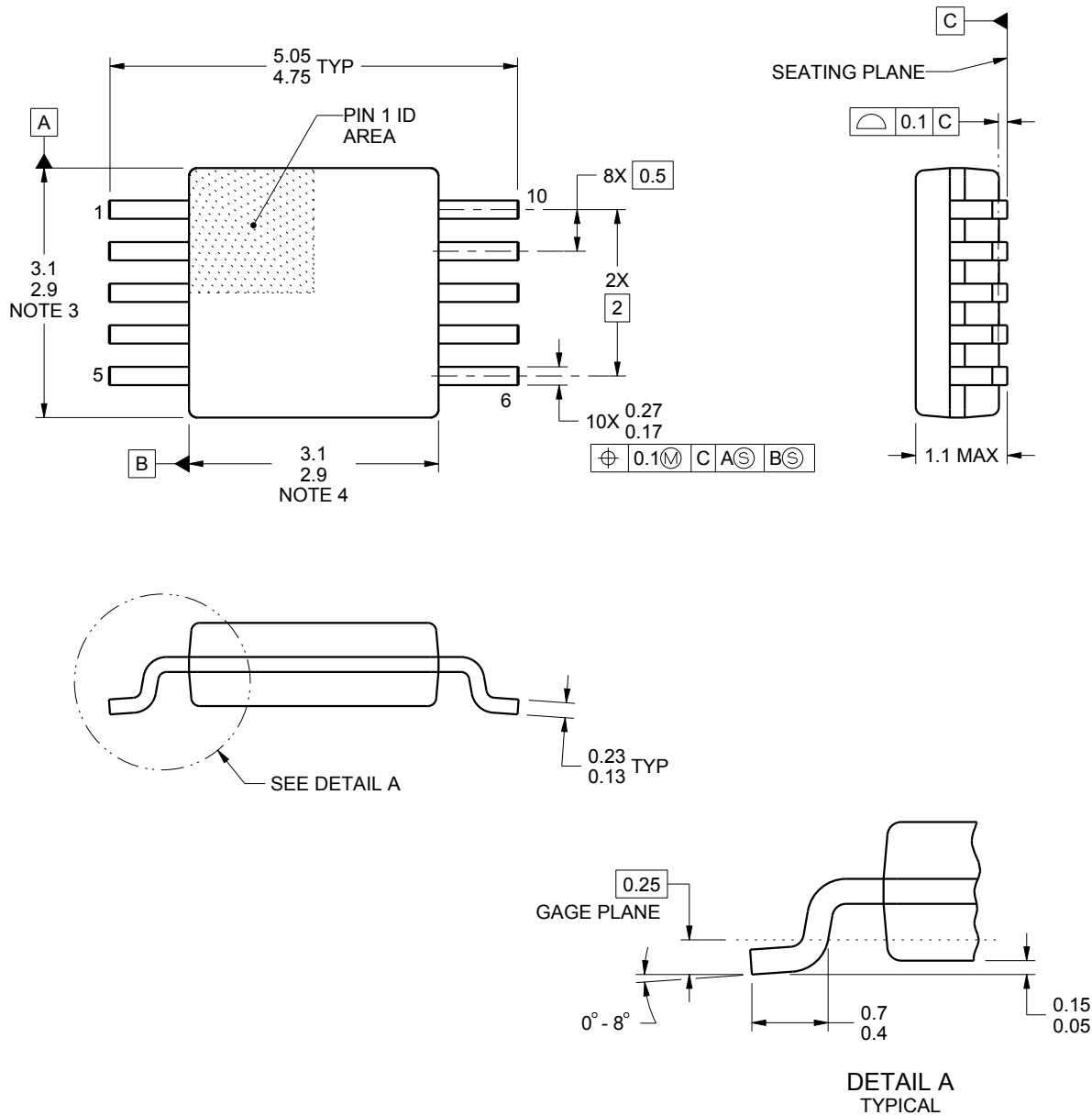
Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TMP461MDGSTEP	VSSOP	DGS	10	250	177.8	12.4	5.3	3.4	1.4	8.0	12.0	Q1

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TMP461MDGSTEP	VSSOP	DGS	10	250	208.0	191.0	35.0



4221984/A 05/2015

NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-187, variation BA.

EXAMPLE BOARD LAYOUT

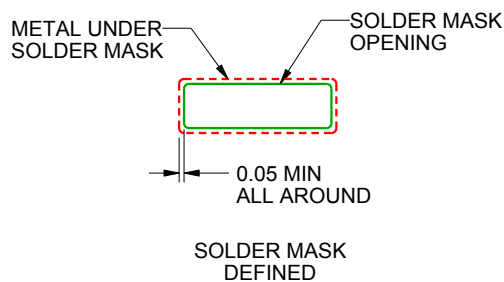
DGS0010A

VSSOP - 1.1 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE
SCALE:10X



SOLDER MASK DETAILS
NOT TO SCALE

4221984/A 05/2015

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

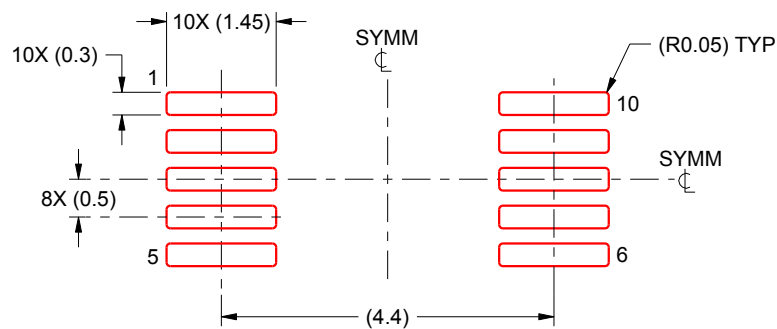
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

DGS0010A

VSSOP - 1.1 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:10X

4221984/A 05/2015

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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